



# MDY14N045RH

Single N-channel Trench MOSFET 135V 4.5mΩ 228A

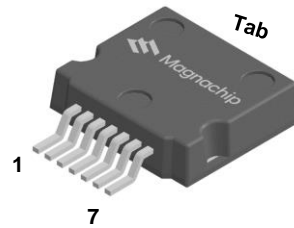
## General description

MDY14N045RH uses advanced Magnachip's MV MOSFET Technologies, which provides high performance in on-state resistance, fast switching, parallel performance and excellent quality.

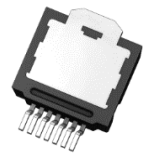
MDY14N045RH is the best solution for high power application where thermal behavior.

Driver source pin avoids gate ringing and false triggering which would normally require switching loss to be limited to manage the source stray inductance of normal package.

## M2PAK-7P



Top View



Bottom View

## Features and benefits

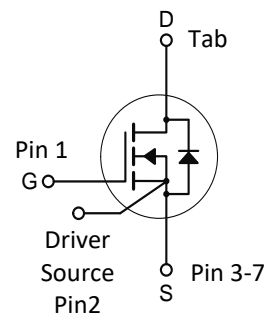
- Very low on-resistance  $R_{DS(on)}$
- 100% Avalanche /  $R_g$  /  $\Delta V_{DS}$  Tested
- High Reliability Package Solution

## Applications

- Motor Inverter
- Battery Management
- Power Inverter

## Key performance parameters

$V_{DS}$	135	V
$R_{DS(on), max}$	0.0045	$\Omega$
$I_D$	228	A
$Q_G$	154	nC
Junction temperature, $_{max}$	175	$^{\circ}C$



## Ordering information

Type / Ordering Code	Package	Marking	Packing	RoHS Status
MDY14N045RH	M2PAK-7P	14N045	Tape & Reel	Halogen Free

<http://www.magnachip.com/powersolutions>



**Maximum ratings**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter		Symbol	Rating	Unit
Drain-source Voltage		$V_{DS}$	135	V
Gate-source Voltage		$V_{GS}$	$\pm 20$	V
Drain current	$T_C=25^\circ\text{C}$ Silicon Limited	$I_D$	228	A
	$T_C=100^\circ\text{C}$ Silicon Limited		161	A
<sup>1)</sup> Pulsed drain current	$T_C=25^\circ\text{C}$	$I_{DM}$	912	A
Total power dissipation	$T_C=25^\circ\text{C}$	$P_{tot}$	469	W
	$T_C=100^\circ\text{C}$		234	W
<sup>2)</sup> Avalanche energy, single pulse		$E_{AS}$	761	mJ
Operating and storage temperature		$T_j, T_{stg}$	- 55 ~ 175	$^\circ\text{C}$

**Thermal characteristics**

Parameter		Symbol	Rating	Unit
Thermal resistance, junction - case		$R_{\theta JC}$	0.32	$^\circ\text{C/W}$
<sup>3)</sup> Thermal resistance, junction - ambient		$R_{\theta JA}$	30	$^\circ\text{C/W}$

**Notes**

- Pulse width limited by  $T_{jmax}$
- EAS is tested at starting  $T_j = 25^\circ\text{C}$ ,  $L = 1.0\text{mH}$ ,  $I_{AS} = 40\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $V_{GS} = 10\text{V}$
- Surface mounted FR-4 board by JEDEC (jesd51-7)

Electrical Characteristics ( $T_J = 25^\circ\text{C}$ )

## Static characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions / Note
Drain-source breakdown voltage	$V_{(BR)DSS}$	135	-	-	V	$V_{GS}=0\text{ V}$ , $I_D=250\ \mu\text{A}$
Gate threshold voltage	$V_{GS(th)}$	2.5	-	3.9	V	$V_{DS}=V_{GS}$ , $I_D=250\ \mu\text{A}$
Zero gate voltage drain current	$I_{DSS}$	-	-	1	$\mu\text{A}$	$V_{DS}=135\text{ V}$ , $V_{GS}=0\text{ V}$
Gate-source leakage current	$I_{GSS}$	-	-	$\pm 100$	nA	$V_{GS}=\pm 20\text{ V}$ , $V_{DS}=0\text{ V}$
Drain-source on-state resistance	$R_{DS(on)}$	-	3.8	4.5	m $\Omega$	$V_{GS}=10\text{ V}$ , $I_D=100\text{ A}$
Gate resistance	$R_G$	-	3.0	-	$\Omega$	$f=1\text{MHz}$
Transconductance	$g_{fs}$	-	120	-	S	$V_{DS}=10\text{ V}$ , $I_D=100\text{ A}$

## Dynamic characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions / Note
Input capacitance	$C_{iss}$	-	11635	-	pF	$V_{GS}=0\text{ V}$ , $V_{DS}=70\text{ V}$ , $f=1\text{ MHz}$
Output capacitance	$C_{oss}$	-	950	-	pF	$V_{GS}=0\text{ V}$ , $V_{DS}=70\text{ V}$ , $f=1\text{ MHz}$
Reverse transfer capacitance	$C_{rss}$	-	12	-	pF	$V_{GS}=0\text{ V}$ , $V_{DS}=70\text{ V}$ , $f=1\text{ MHz}$
Turn-on delay time	$t_{d(on)}$	-	43	-	ns	$V_{DD}=70\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=100\text{ A}$ , $R_{G,ext}=3\Omega$
Rise time	$t_r$	-	21	-	ns	$V_{DD}=70\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=100\text{ A}$ , $R_{G,ext}=3\Omega$
Turn-off delay time	$t_{d(off)}$	-	102	-	ns	$V_{DD}=70\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=100\text{ A}$ , $R_{G,ext}=3\Omega$
Fall time	$t_f$	-	18	-	ns	$V_{DD}=70\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=100\text{ A}$ , $R_{G,ext}=3\Omega$

## Gate charge characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions / Note
Gate to source charge	$Q_{gs}$	-	55	-	nC	$V_{DD}=70\text{ V}$ , $I_D=100\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$
Gate charge at threshold	$Q_{gs(th)}$	-	46	-	nC	$V_{DD}=70\text{ V}$ , $I_D=100\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$
Gate to drain charge	$Q_{gd}$	-	31	-	nC	$V_{DD}=70\text{ V}$ , $I_D=100\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$
Switching charge	$Q_{sw}$	-	40	-	nC	$V_{DD}=70\text{ V}$ , $I_D=100\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$
Gate charge total	$Q_g$	-	154	-	nC	$V_{DD}=70\text{ V}$ , $I_D=100\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$
Gate plateau voltage	$V_{plateau}$	-	4.8	-	V	$V_{DD}=70\text{ V}$ , $I_D=100\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$

## Source-drain diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions / Note
Diode continuous forward current	$I_S$	-	-	228	A	-
Diode pulse current	$I_{S,pulse}$	-	-	912	A	pulsed; $t_p \leq 10\ \mu\text{s}$
Diode forward voltage	$V_{SD}$	-	1.0	1.2	V	$V_{GS}=0\text{ V}$ , $I_F=100\text{ A}$
Reverse recovery time	$t_{rr}$	-	128	-	ns	$I_F=100\text{ A}$ , $dI_F/dt=100\text{ A}/\mu\text{s}$
Reverse recovery charge	$Q_{rr}$	-	560	-	nC	$I_F=100\text{ A}$ , $dI_F/dt=100\text{ A}/\mu\text{s}$

Electrical characteristics diagrams

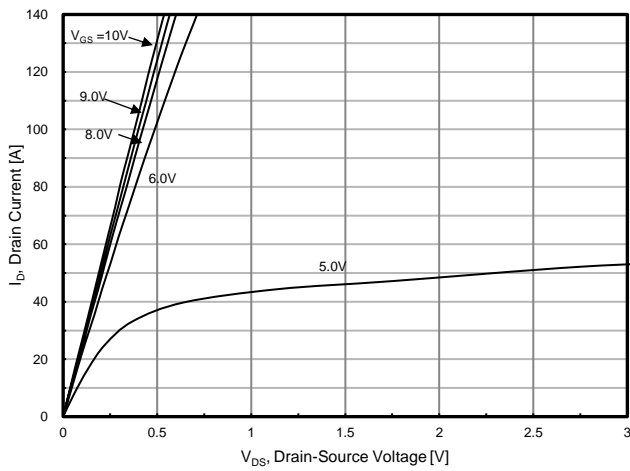


Fig. 1. Output Characteristics

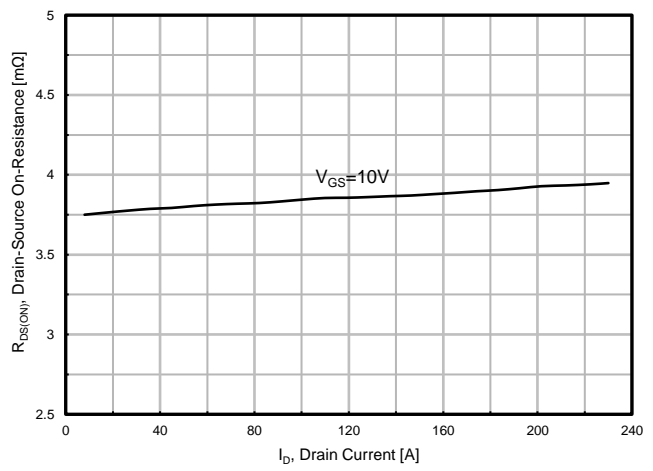


Fig. 2. Static On-Resistance Variation

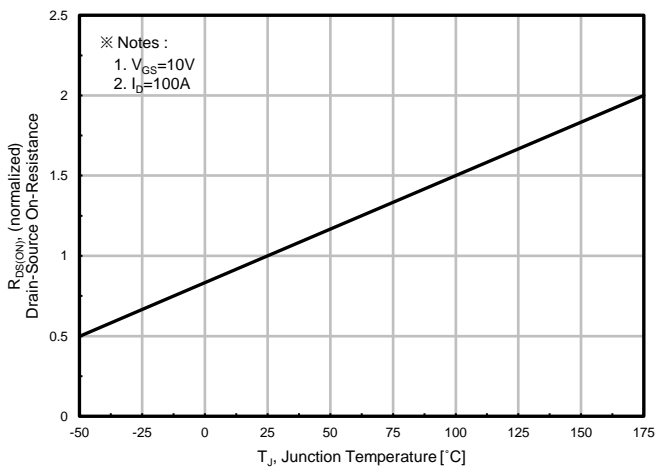


Fig. 3. On-Resistance vs. Junction Temperature

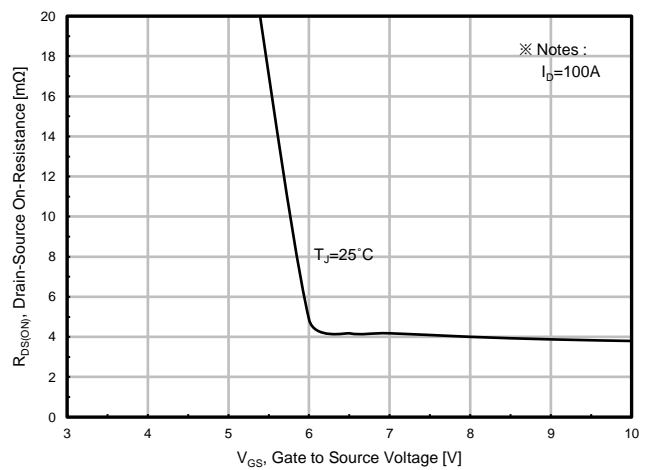


Fig. 4. On-Resistance vs. Gate to Source Voltage

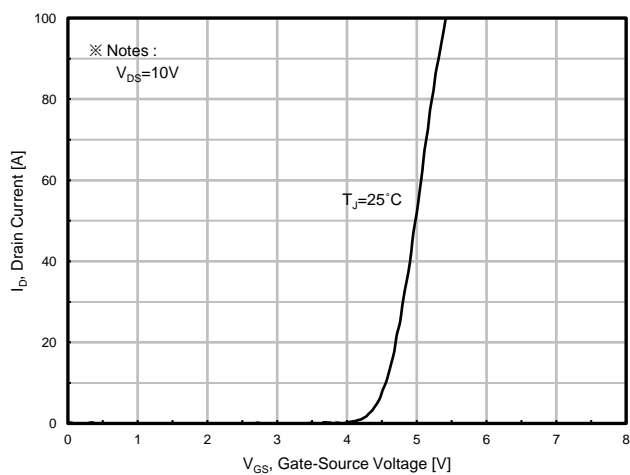


Fig. 5. Transfer Characteristics

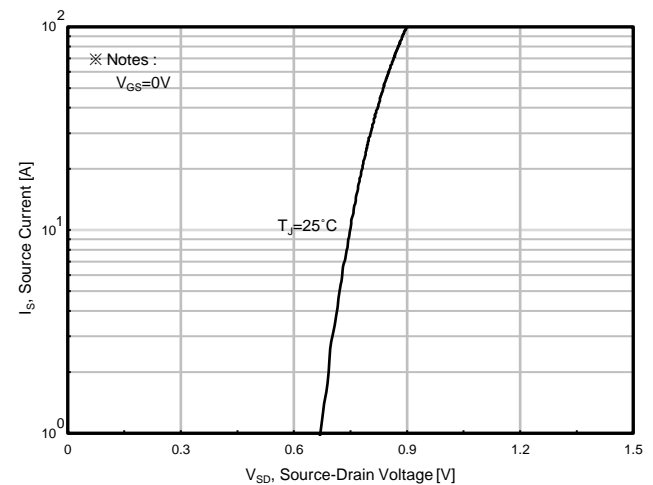


Fig. 6. Body Diode Forward Voltage Variation with Source Current and Temperature

Electrical characteristics diagrams

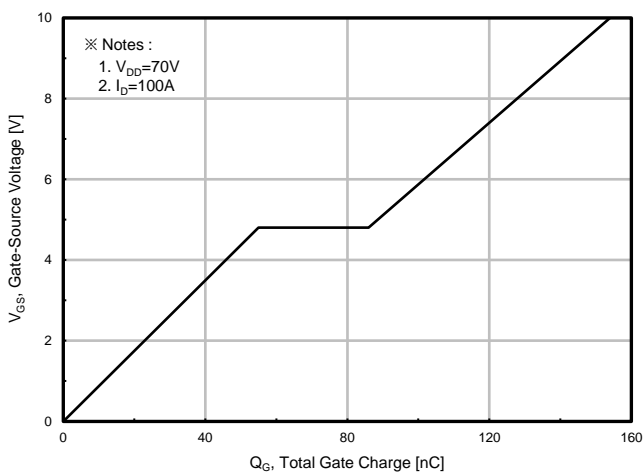


Fig. 7. Gate Charge

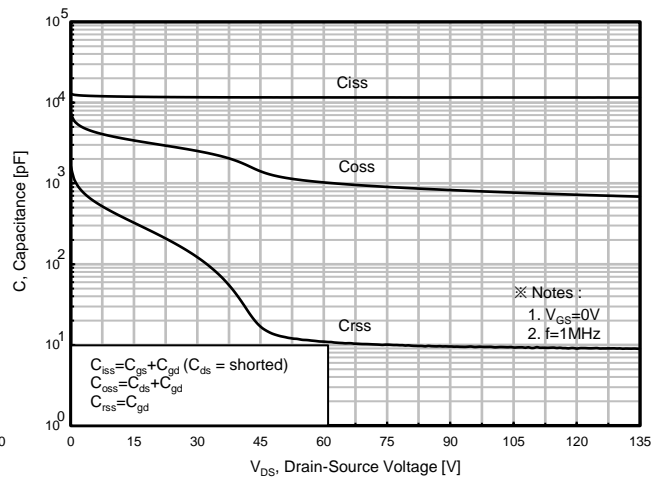


Fig. 8. Capacitances

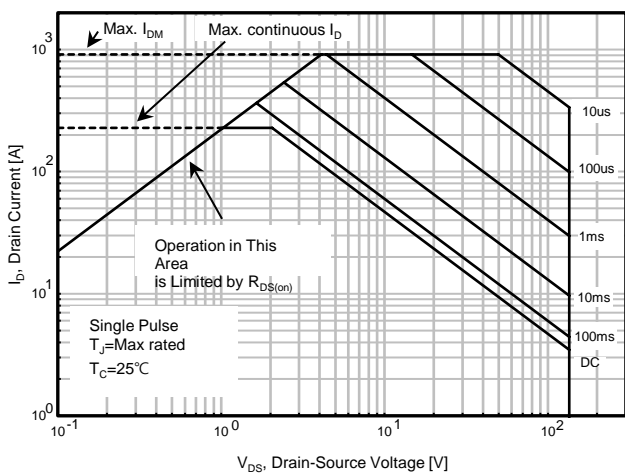


Fig. 9. Safe Operating Area

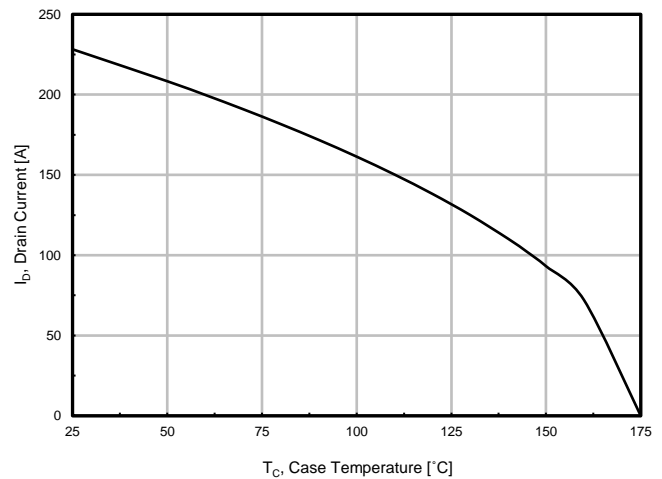


Fig. 10. Maximum Drain Current vs. Case Temperature

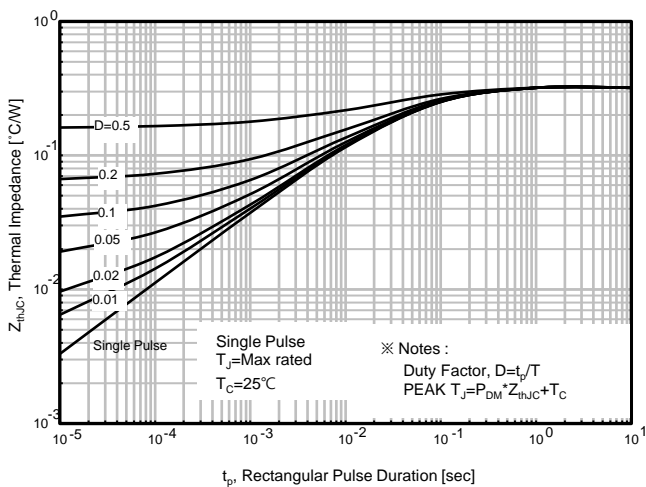
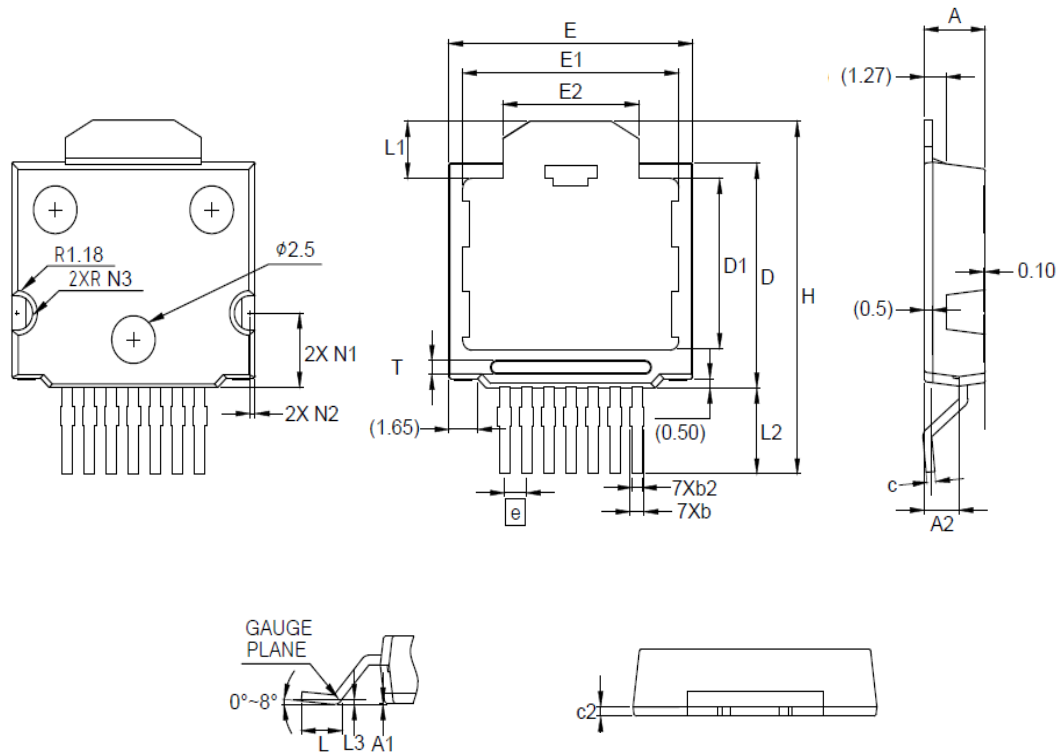


Fig. 11. Transient Thermal Impedance

# Package information

## M2PAK-7P




Symbol	Dimension (mm)		
	Min	Nom	Max
A	3,40	-	3,60
A1	0,00	-	0,25
A2	1,80	-	2,20
b	0,50	-	0,70
b2	0,50	-	1,00
c	0,40	-	0,60
c2	0,40	-	0,60
D	11,70	-	11,90
D1	8,90	-	9,10
E	13,90	-	14,10
E1	12,30	-	12,50
E2	7,75	-	7,85
T	0,60		0,70
e	BSC 1,27		
H	18,00	-	19,00
L	2,22	-	2,42
L1	2,90	-	3,10
L2	4,35	-	4,65
L3	BSC 0,25		
N1	3,80	-	4,00
N2	0,25	-	0,35
N3	0,80	-	1,00

Note : Package body size, length and width do not include mold flash, protrusions and gate burrs.

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